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Nonthermal and Advanced Food Processing Technologies: Industry 4.0 and Sustainability

Guest Editors:

Message from the Guest Editors

Prof. Dr. Anet Režek Jambrak

Prof. Dr. Farid Chemat

Prof. Dr. Giovanna Ferrari

Dr. Sanda Pleslić

Deadline for manuscript submissions: closed (30 April 2021) Research and review papers on the application of artificial intelligence (Al), deep learning, machine learning, cybersecurity and blockchain future application in nonthermal and advanced thermal processing will be highly welcomed. The idea of applying the aforementioned nonthermal and advanced thermal techniques is lower working temperatures, reduce energy consumption, lower carbon footprint, reduce water depletion and improve life cycle assessment parameters. Nonthermal and advanced thermal techniques working in line with the sustainable techniques working in line with the sustainable development goals (SDG) and Agenda 2030 issued by United Nations (UN).

- nonthermal techniques
- advanced thermal techniques
- industry 4.0
- digitalization
- internet of things (IoT)
- additive technologies (3D printing)
- sustainability
- artificial intelligence (AI), cybersecurity
- blockchain









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Editor-in-Chief

Message from the Editor-in-Chief

Prof. Dr. Giulio Nicola Cerullo Dipartimento di Fisica, Politecnico di Milano, Piazza L. da Vinci 32, 20133 Milano, Italy As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal Applied Sciences has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

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